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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









75 MHz, 30 dB gain reverse amplifier Rev. 5 — 28 September 2010

**Product data sheet** 

#### 1. **Product profile**

### 1.1 General description

Hybrid high dynamic range amplifier module in a SOT115J package operating at a voltage supply of 24 V (DC).

### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### 1.2 Features and benefits

- Excellent linearity
- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- Gold metallization ensures excellent reliability

### 1.3 Applications

Reverse amplifier in two-way CATV systems in the 5 MHz to 75 MHz frequency range

#### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	N	Min	Тур	Max	Unit
Gp	power gain	f = 10 MHz	2	29.2	-	30.8	dB
I <sub>tot</sub>	total current consumption (DC)		[1] -		-	135	mA

<sup>[1]</sup> The module normally operates at  $V_B = 24 \text{ V}$ , but is able to withstand supply transients up to 30 V.



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# 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	input		
2	common	1 3 5 7 9	5
3	common		$\frac{1}{2}$
5	+V <sub>B</sub>		2 3 7 8
7	common		sym095
8	common		·
9	output		

# 3. Ordering information

Table 3. Ordering information

Туре	Package					
number	Name	Description	Version			
BGY68	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2\times 6\text{-}32$ UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J			

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_i$	RF input voltage		-	55	dBmV
T <sub>stg</sub>	storage temperature		-40	+100	°C
T <sub>mb</sub>	mounting base temperature	е	-20	+100	°C

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# 5. Characteristics

Table 5. Characteristics

Bandwidth 5 MHz to 75 MHz;  $V_B = 24$  V;  $T_{mb} = 30$  °C;  $Z_S = Z_L = 75$   $\Omega$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 10 MHz	29.2	-	30.8	dB
SL	slope cable equivalent	f = 5 MHz to 75 MHz	-0.2	-	+0.5	dB
FL	flatness of frequency response	f = 5 MHz to 75 MHz	-	-	±0.2	dB
S <sub>11</sub>	input return losses	f = 5 MHz to 75 MHz	20	-	-	dB
S <sub>22</sub>	output return losses	f = 5 MHz to 50 MHz	20	-	-	dB
		f = 50 MHz to 75 MHz	18	-	-	dB
СТВ	composite triple beat	4 channels flat; $V_0 = 50 \text{ dBmV}$ ; measured at 25 MHz	-	-	-68	dB
$X_{mod}$	cross modulation	4 channels flat; $V_0 = 50 \text{ dBmV}$ ; measured at 25 MHz	-	-	-60	dB
d <sub>2</sub>	second order distortion		<u>[1]</u> _	-	-70	dB
F	noise figure	f = 75 MHz	-	-	3.5	dB
I <sub>tot</sub>	total current consumption (DC)		[2] _	-	135	mA

<sup>[1]</sup>  $f_p$  = 19 MHz;  $V_p$  = 50 dBmV;  $f_q$  = 31 MHz;  $V_q$  = 50 dBmV; measured at  $f_p$  +  $f_q$  = 50 MHz.

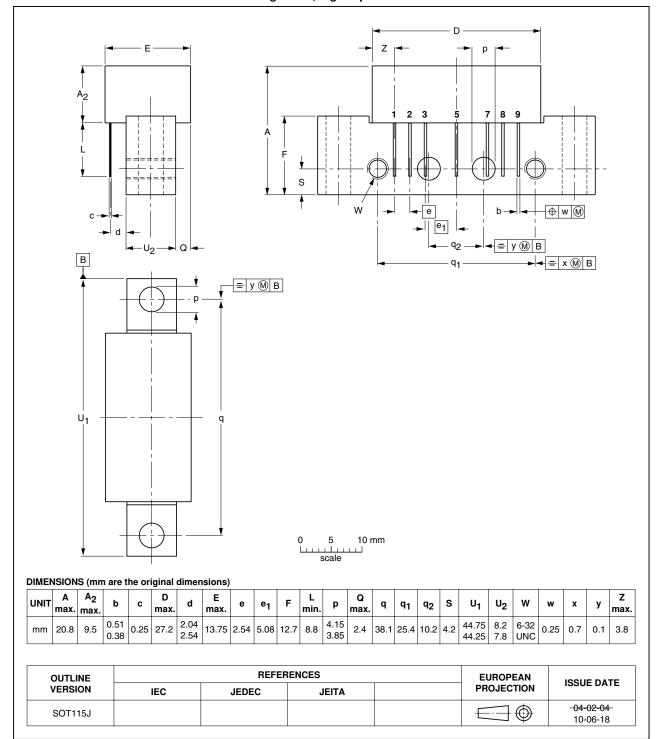
<sup>[2]</sup> The module normally operates at  $V_B = 24 \ V$ , but is able to withstand supply transients up to 30 V.

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#### **Package outline** 6.

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



Package outline SOT115J Fig 1.

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# 7. Revision history

## Table 6. Revision history

Release date	Data sheet status	Change notice	Supersedes
20100928	Product data sheet	-	BGY68 v.4
of NXP Semi	conductors. ave been adapted to the new	company name where	appropriate.
<ul> <li>Package outl</li> </ul>	ine drawings have been upda	ted to the latest versio	n.
20050314	Product data sheet	-	BGY68 v.3
20011018	Product specification	-	BGY68 v.2
19970414	Product specification	-	BGY68 v.1
	The format of of NXP Seminary Semi	<ul> <li>20100928 Product data sheet</li> <li>The format of this data sheet has been rede of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new Package outline drawings have been upda</li> <li>20050314 Product data sheet</li> <li>20011018 Product specification</li> </ul>	Product data sheet

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## 8. Legal information

#### 8.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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